Test Data
For PMP20808
March 14, 2017

Texas Instruments
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1. Design Specifications

<table>
<thead>
<tr>
<th>Specification</th>
<th>Value</th>
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<tbody>
<tr>
<td>Vin Minimum</td>
<td>36VDC</td>
</tr>
<tr>
<td>Vin Nominal</td>
<td>38VDC</td>
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<tr>
<td>Vin Maximum</td>
<td>40VDC</td>
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<tr>
<td>Vout</td>
<td>25VDC</td>
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<tr>
<td>Iout</td>
<td>18A Max.</td>
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<td>Switching Frequency</td>
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2. Circuit Description

PMP20808 is a Single-Phase Synchronous Buck Converter using the LM5117 controller IC. The design accepts an input voltage of 36Vin to 40Vin (38Vin Nominal) and provides an output of 25Vout capable of supplying 18A of continuous current to the load. The design was built on the PMP9280 PCB, which was modified to the PMP20808 design configuration and requirements. The PCB is a 4-layer board with 1oz Copper on all layers.
3. PMP20808 Board Photos

Board Dimensions: 2.36” x 4.05”

**Board Photo (Top)**

**Board Photo (Bottom)**
4. Thermal Data

IR thermal image taken at steady state with 38Vin and 18A load (no airflow; ambient at room temp.)
5. Efficiency

5.1 Efficiency Chart

![Efficiency Chart](image)

5.2 Efficiency Data

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<tr>
<th>Vin (V)</th>
<th>Iin (A)</th>
<th>Vout (V)</th>
<th>Iout (A)</th>
<th>Pin (W)</th>
<th>Pout (W)</th>
<th>Ploss (W)</th>
<th>Efficiency (%)</th>
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6 Waveforms

6.1 Load Transient Response

Load Transient Response at 38Vin and 9A-to-18A (50%-to-100%) Load Step
6.2 Startup

Startup into No Load at 38Vin
Startup into 18A Constant-Current Load at 38Vin
6.3 Output Voltage Ripple and Switch Node Voltage

Switch Node Voltage and Output Voltage Ripple at 38Vin and 18A Load (Vripple ≈ 185mVp-p)
6.4 Short Circuit

Short Circuit Application and Recovery at 38Vin from/into No Load
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